

150mA, 75V Switching Diode

FEATURES

- Low power loss, high efficiency
- Ideal for automated placement
- High surge current capability
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I _F	150	mA	
V_{RRM}	75	V	
I _{FSM}	2	Α	
V _F at I _F =150mA	1.25	V	
T _{J MAX}	150	°C	
Package	SOT-23		
Configuration	Single die		

APPLICATIONS

• Switching mode power supply (SMPS)



MECHANICAL DATA

• Case: SOT-23

• Molding compound meets UL 94 V-0 flammability rating

• Moisture sensitivity level: level 1, per J-STD-020

• Terminal: Matte tin plated leads, solderable per J-STD-002

• Meet JESD 201 class 1A whisker test

• Weight: 8± 0.5 mg (approximately)





ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)			
PARAMETER	SYMBOL	BAS16	UNIT
Marking code on the device		A6	
Repetitive peak reverse voltage	V_{RRM}	75	V
Forward current	I _F	150	mA
Non-repetitive peak forward surge current @t = 0.001 s	I _{FSM}	2	Α
Junction temperature range	T _J	-65 to +150	°C
Storage temperature range	T _{STG}	-65 to +150	°C





THERMAL PERFORMANCE			
PARAMETER	SYMBOL	TYP	UNIT
Junction-to-ambient thermal resistance	$R_{\Theta JA}$	375	°C/W

ELECTRICAL SPECIFICATIONS (T _A = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	CONDITIONS SYMBOL		MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 1.0 \text{mA}, T_J = 25^{\circ}\text{C}$		-	0.715	V
	I _F = 10mA, T _J = 25°C			0.855	
	I _F = 50mA, T _J = 25°C	V _F		1.000	
	I _F = 150mA, T _J = 25°C			1.250	
Reverse current $^{(2)}$ $V_R=75V T_J=25^{\circ}C$		I _R	-	1	μA
Junction capacitance	f=1 MHz, V _R =0V	CJ	-	2	pF
Reverse recovery time		t _{rr}		4	ns

Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

ORDERING INFORMATION			
ORDERING CODE	PACKAGE	PACKING	
BAS16 RF	SOT-23	3K / 7" Reel	
BAS16 RFG	SOT-23	3K / 7" Reel	
BAS16 R5	SOT-23	10K / 13" Reel	
BAS16 R5G	SOT-23	10K / 13" Reel	



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Typical Forward Characteristics

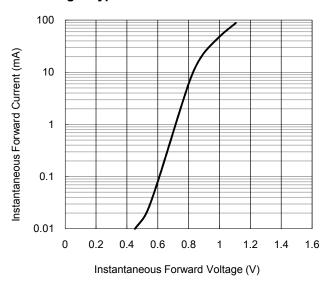


Fig.2 Reverse Current VS. Reverse Voltage

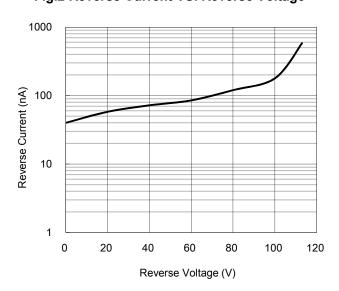


Fig.3 Admissible Power Dissipation Curve

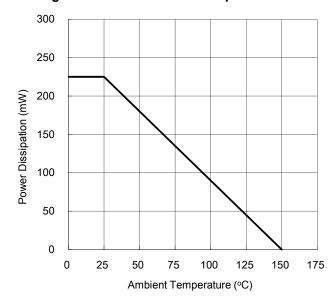
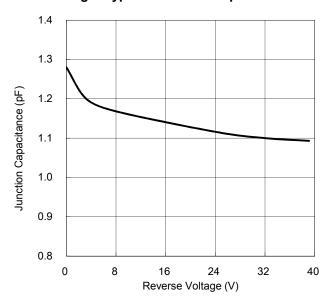


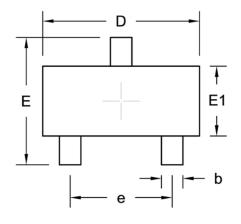
Fig.4 Typical Junction Capacitance

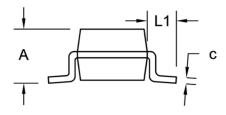




PACKAGE OUTLINE DIMENSION

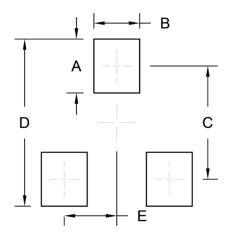
SOT-23





DIM.	Unit (mm)		Unit	(inch)
DIIVI.	Min.	Max.	Min.	Max.
Α	0.89	1.12	0.035	0.044
b	0.30	0.50	0.012	0.020
С	0.08	0.20	0.003	0.008
D	2.80	3.04	0.110	0.120
E	2.10	2.64	0.083	0.104
E1	1.20	1.40	0.047	0.055
е	1.90	BSC	0.07	5 BSC
L1	0.54 REF.		0.02	1 REF.

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	1.00	0.039
В	0.85	0.033
С	2.10	0.083
D	3.10	0.122
E	0.98	0.039



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